

Features

- 30A Peak Source/Sink Drive Current
- High Operating Voltage Capability: 35V
- -40°C to +125°C Extended Operating Temperature Range
- Under-Voltage Lockout Protection
- Logic Input Withstands Negative Swing of up to 5V
- Fast Rise and Fall Times: < 20ns
- Low Propagation Delay Time
- Low 10µA Supply Current
- Low Output Impedance

Applications

- Efficient Power MOSFET and IGBT Switching
- Switch Mode Power Supplies
- Motor Controls
- DC to DC Converters
- Class-D Switching Amplifiers
- Pulse Transformer Driver



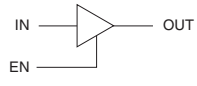
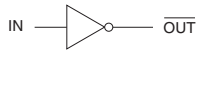
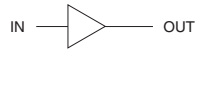
Description

The IXDD630/IXDI630/IXDN630 high-speed gate drivers are especially well suited for driving the latest IXYS power MOSFETs and IGBTs. The IXD_630 output can source and sink 30A of peak current while producing voltage rise and fall times of less than 20ns. Internal circuitry eliminates cross conduction and current "shoot-through," and the driver is virtually immune to latch up. Under-voltage lockout (UVLO) circuitry holds the output LOW until sufficient supply voltage is applied (12.5V for the IXD_630 versions, and 9V for the IXD_630M versions). Low propagation delays and fast, matched rise and fall times make the IXD_630 family ideal for very high frequency and high-power applications.

The IXDD630 is configured as a non-inverting driver with an enable. The IXDN630 is configured as a non-inverting driver, and the IXDI630 is configured as an inverting driver.

The IXD_630 family is available in a 5-pin TO-220 (CI), and a 5-pin TO-263 (YI) package.

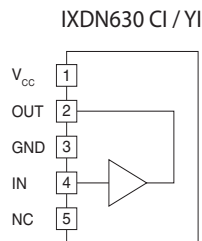
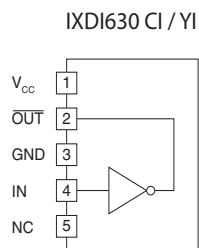
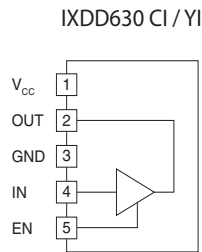
Ordering Information

Part Number	Logic Configuration	UVLO	Package Type	Packing Method	Quantity
IXDD630CI		12.5V	5-Pin TO-220	Tube	50
IXDD630MCI		9V	5-Pin TO-220	Tube	50
IXDD630YI		12.5V	5-Pin TO-263	Tube	50
IXDD630MYI		9V	5-Pin TO-263	Tube	50
IXDI630CI		12.5V	5-Pin TO-220	Tube	50
IXDI630MCI		9V	5-Pin TO-220	Tube	50
IXDI630YI		12.5V	5-Pin TO-263	Tube	50
IXDI630MYI		9V	5-Pin TO-263	Tube	50
IXDN630CI		12.5V	5-Pin TO-220	Tube	50
IXDN630MCI		9V	5-Pin TO-220	Tube	50
IXDN630YI		12.5V	5-Pin TO-263	Tube	50
IXDN630MYI		9V	5-Pin TO-263	Tube	50

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1 Specifications

1.1 Lead Configurations



1.2 Lead Definitions

Lead Name	Description
IN	Logic Input
EN	Output Enable - Drive lead low to disable output, and force output to a high impedance state
OUT	Output - Sources or sinks current to turn-on or turn-off a discrete MOSFET or IGBT
$\overline{\text{OUT}}$	Inverted Output - Sources or sinks current to turn-on or turn-off a discrete MOSFET or IGBT
V _{CC}	Supply Voltage - Provides power to the device
GND	Ground - Common ground reference for the device
NC	Not connected

1.3 Absolute Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Units
Supply Voltage	V _{CC}	-0.3	40	V
Input Voltage Range	V _{IN} , V _{EN}	-5	V _{CC} +0.3	V
Output Current	I _{OUT}	-	±30	A
Junction Temperature	T _J	-55	+150	°C
Storage Temperature	T _{STG}	-65	+150	°C

Unless stated otherwise, absolute maximum electrical ratings are at 25°C

Absolute maximum ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

1.4 Recommended Operating Conditions

Parameter	Symbol	Range	Units
Supply Voltage	V_{CC}	UVLO to 35	V
Operating Temperature Range	T_A	-40 to +125	°C

1.5 Electrical Characteristics: $T_A = 25^\circ\text{C}$

Test Conditions: $UVLO \leq V_{CC} \leq 35\text{V}$ (unless otherwise noted).

Parameter	Conditions	Symbol	Minimum	Typical	Maximum	Units
Input Voltage, High	$UVLO \leq V_{CC} \leq 18\text{V}$	V_{IH}	3.5	-	-	V
Input Voltage, Low	$UVLO \leq V_{CC} \leq 18\text{V}$	V_{IL}	-	-	0.8	
Input Current	$0\text{V} \leq V_{IN} \leq V_{CC}$	I_{IN}	-	-	± 10	μA
EN Input Voltage, High	IXDD630 only	V_{ENH}	$2/3V_{CC}$	-	-	V
EN Input Voltage, Low	IXDD630 only	V_{ENL}	-	-	$1/3V_{CC}$	
Output Voltage, High	-	V_{OH}	$V_{CC}-0.025$	-	-	V
Output Voltage, Low	-	V_{OL}	-	-	0.025	
Output Resistance, High State	$V_{CC}=18\text{V}, I_{OUT}=-100\text{mA}$	R_{OH}	-	0.17	0.4	Ω
Output Resistance, Low State	$V_{CC}=18\text{V}, I_{OUT}=100\text{mA}$	R_{OL}	-	0.16	0.3	
Output Current, Continuous	Limited by package power dissipation	I_{DC}	-	-	± 8	A
Rise Time	$C_{LOAD}=5.6\text{nF}, V_{CC}=18\text{V}$	t_r	-	11	20	ns
Fall Time	$C_{LOAD}=5.6\text{nF}, V_{CC}=18\text{V}$	t_f	-	11	18	
On-Time Propagation Delay	$C_{LOAD}=5.6\text{nF}, V_{CC}=18\text{V}$	t_{ondly}	-	46	65	
Off-Time Propagation Delay	$C_{LOAD}=5.6\text{nF}, V_{CC}=18\text{V}$	t_{offdly}	-	46	65	
Output Enable Time	IXDD630 only	t_{PZL}, t_{PZH}	-	34	65	
Output Disable Time	IXDD630 only	t_{PLZ}, t_{PHZ}	-	65	125	
Enable Pull-Up Resistor	IXDD630 only	R_{EN}	-	400	-	$\text{k}\Omega$
Power Supply Current	$V_{CC}=18\text{V}, V_{IN}=3.5\text{V}$	I_{CC}	-	2.5	4	mA
	$V_{CC}=18\text{V}, V_{IN}=0\text{V}$		-	-	0.75	
	$V_{CC}=18\text{V}, V_{IN}=V_{CC}$		-	-	0.75	mA
Under-Voltage Lockout Threshold	V_{CC} Rising, IXD_630M	UVLO	7	9	9.9	
	V_{CC} Rising, IXD_630		10	12.5	13.5	
Under-Voltage Lockout Hysteresis	IXD_630M	-	-	1	-	V
	IXD_630		-	-	1.5	

1.6 Electrical Characteristics: $T_A = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$

 Test Conditions: $UVLO \leq V_{CC} \leq 35\text{V}$, $T_J < 150^{\circ}\text{C}$.

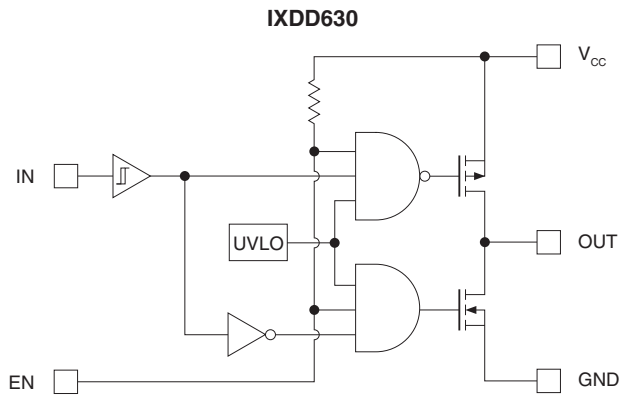
Parameter	Conditions	Symbol	Minimum	Maximum	Units
Input Voltage, High	$UVLO \leq V_{CC} \leq 18\text{V}$	V_{IH}	4	-	V
Input Voltage, Low	$UVLO \leq V_{CC} \leq 18\text{V}$	V_{IL}	-	0.8	
Output Resistance, High State	$V_{CC}=18\text{V}$, $I_{OUT}=-100\text{mA}$	R_{OH}	-	0.6	Ω
Output Resistance, Low State	$V_{CC}=18\text{V}$, $I_{OUT}=100\text{mA}$	R_{OL}	-	0.45	
Rise Time	$C_{LOAD}=5.6\text{nF}$, $V_{CC}=18\text{V}$	t_r	-	35	ns
Fall Time	$C_{LOAD}=5.6\text{nF}$, $V_{CC}=18\text{V}$	t_f	-	35	
On-Time Propagation Delay	$C_{LOAD}=5.6\text{nF}$, $V_{CC}=18\text{V}$	t_{ondly}	-	100	
Off-Time Propagation Delay	$C_{LOAD}=5.6\text{nF}$, $V_{CC}=18\text{V}$	t_{offdly}	-	100	

1.7 Thermal Characteristics

Package	Parameter	Symbol	Rating	Units
IXD_630CI (5-Lead TO-220)	Thermal Resistance, Junction-to-Ambient	θ_{JA}	36	$^{\circ}\text{C}/\text{W}$
IXD_630YI (5-Lead TO-263)			46	
IXD_630CI (5-Lead TO-220)	Thermal Resistance, Junction-to-Case	θ_{JC}	3	$^{\circ}\text{C}/\text{W}$
IXD_630YI (5-Lead TO-263)			2	

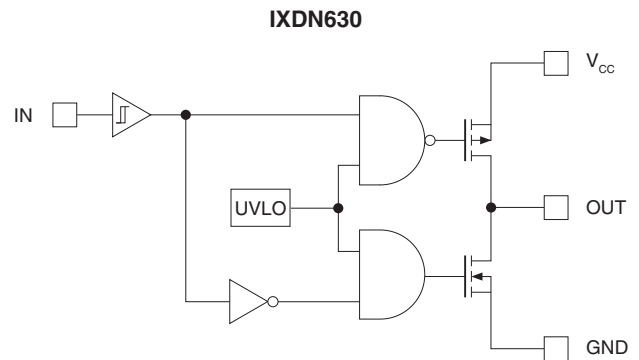
2 Functional Description

2.1 IXDD630 Block Diagram & Truth Table



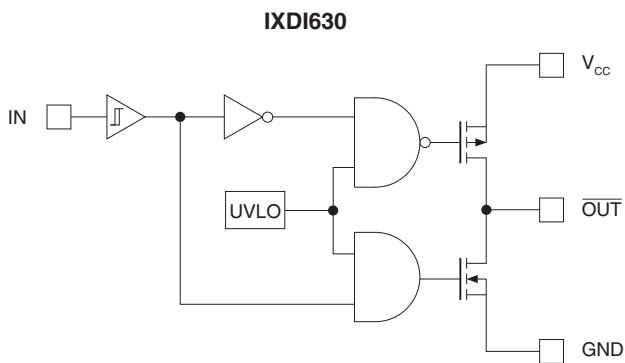
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1	1 or open	1
0	0	Z
1	0	Z

2.3 IXDN630 Block Diagram & Truth Table



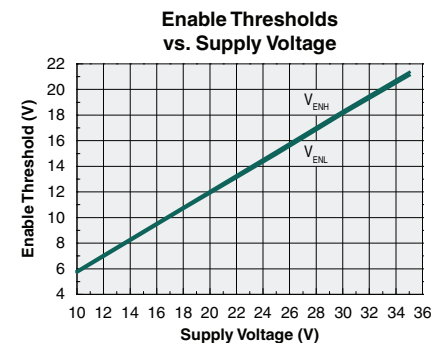
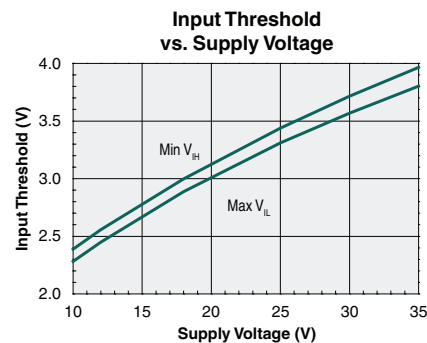
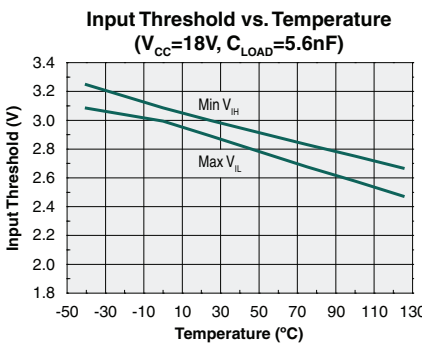
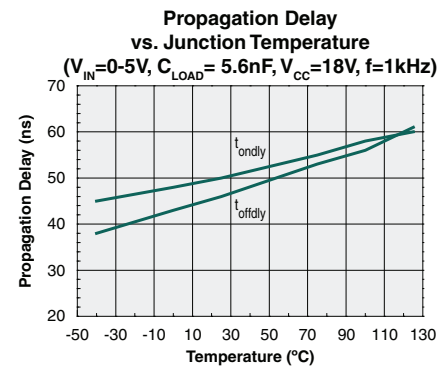
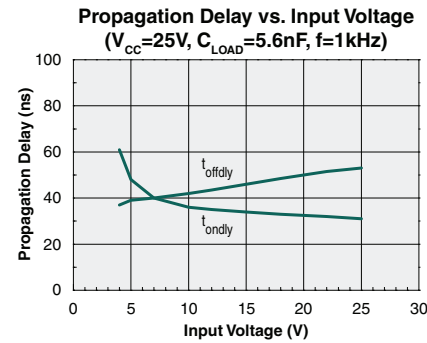
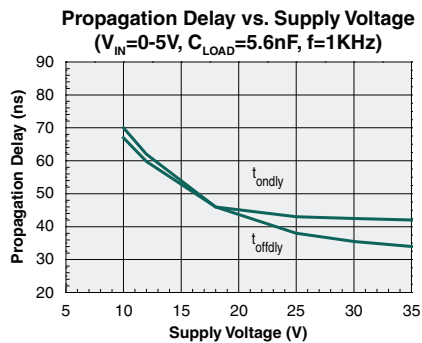
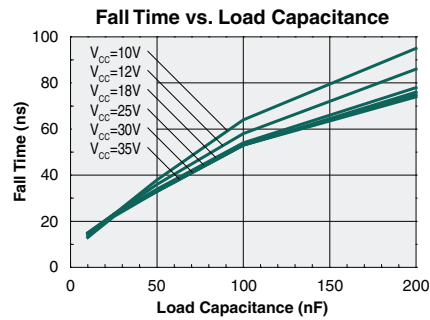
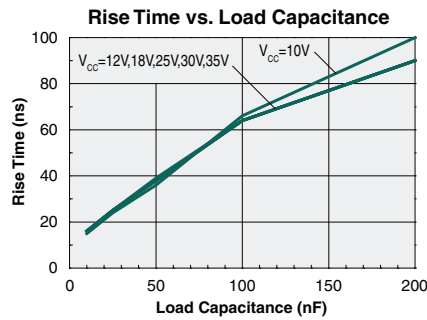
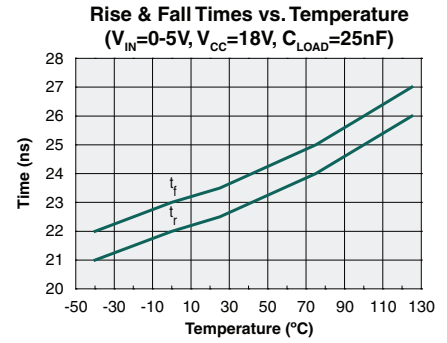
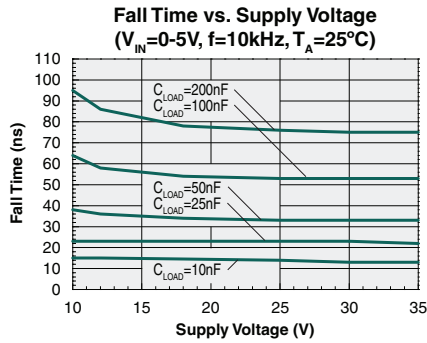
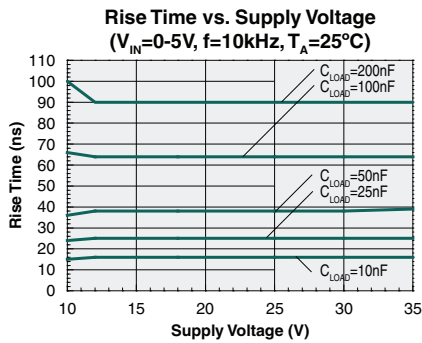
IN	OUT
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1	1

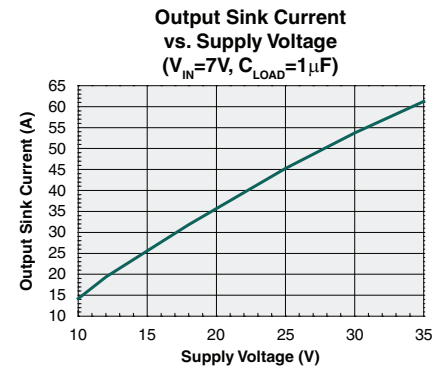
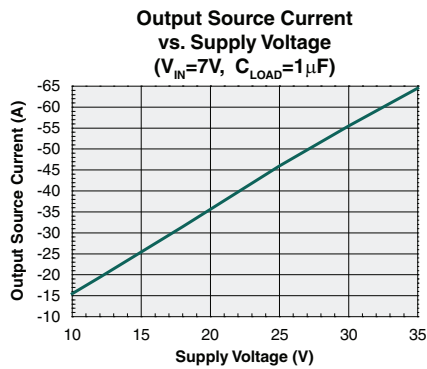
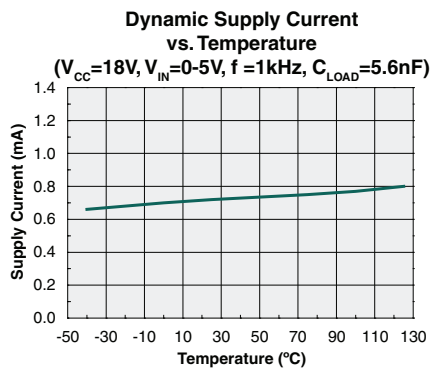
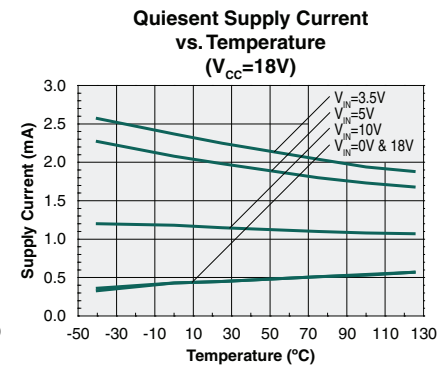
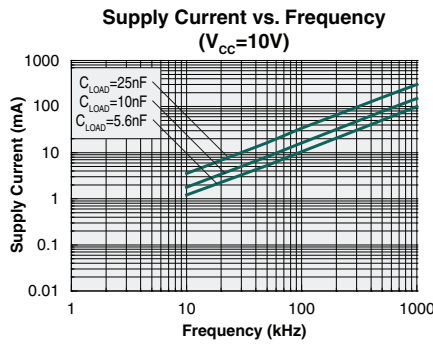
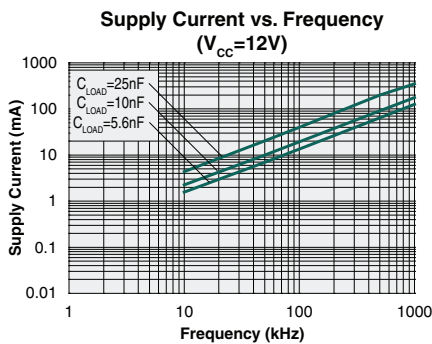
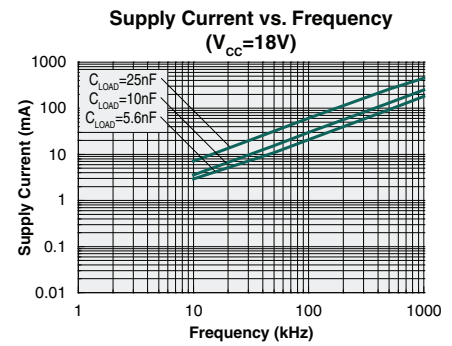
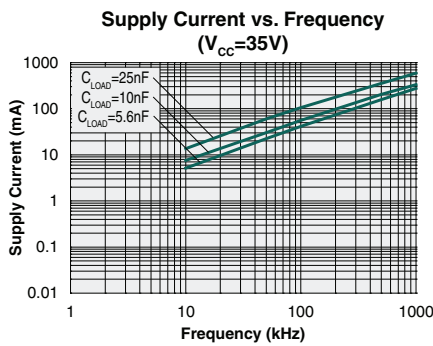
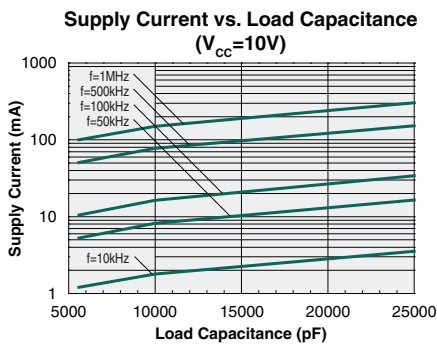
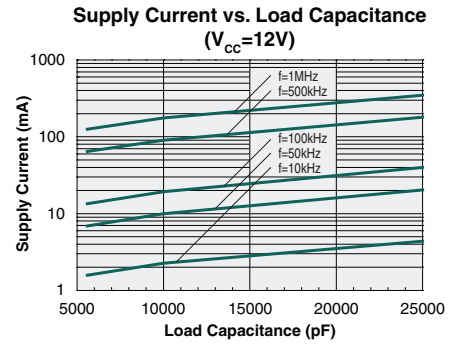
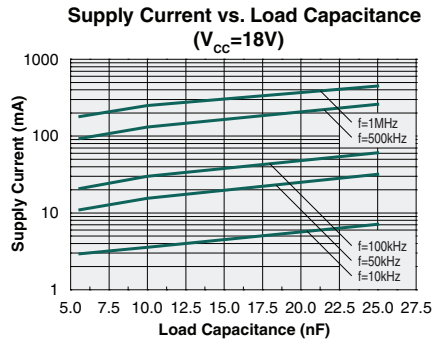
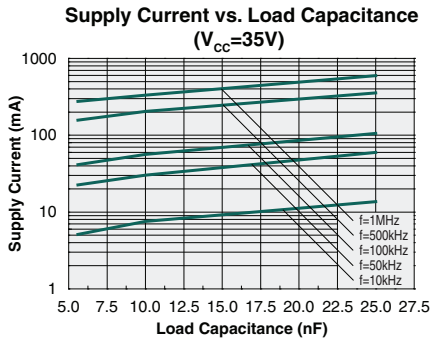
2.2 IXDI630 Block Diagram & Truth Table

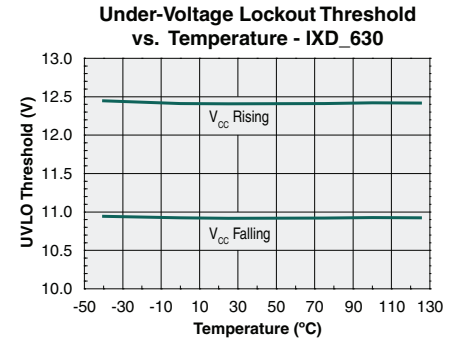
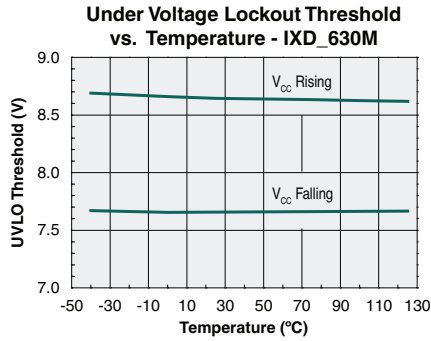
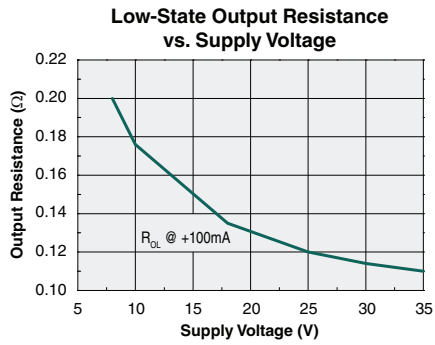
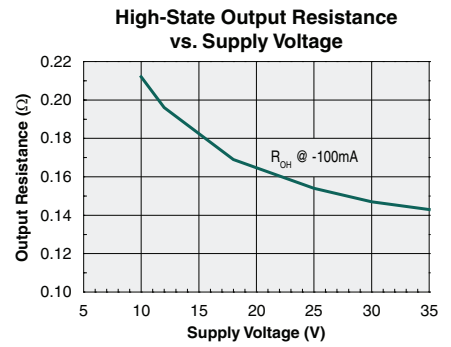
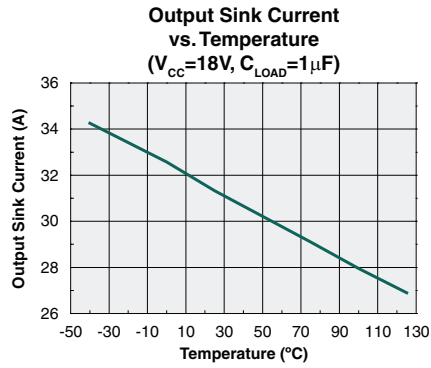
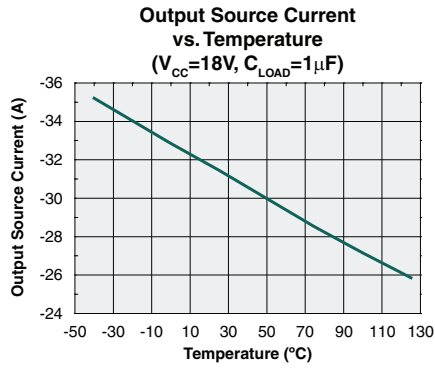


IN	$\overline{\text{OUT}}$
0	1
1	0

3 Typical Performance Characteristics







4 Manufacturing Information

4.1 Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
IXD_630YI / IXD_630MYI / IXD_630CI / IXD_630MCI	MSL1

4.2 ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

4.3 Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
IXD_630YI / IXD_630MYI / IXD_630CI / IXD_630MCI	245°C for 30 seconds

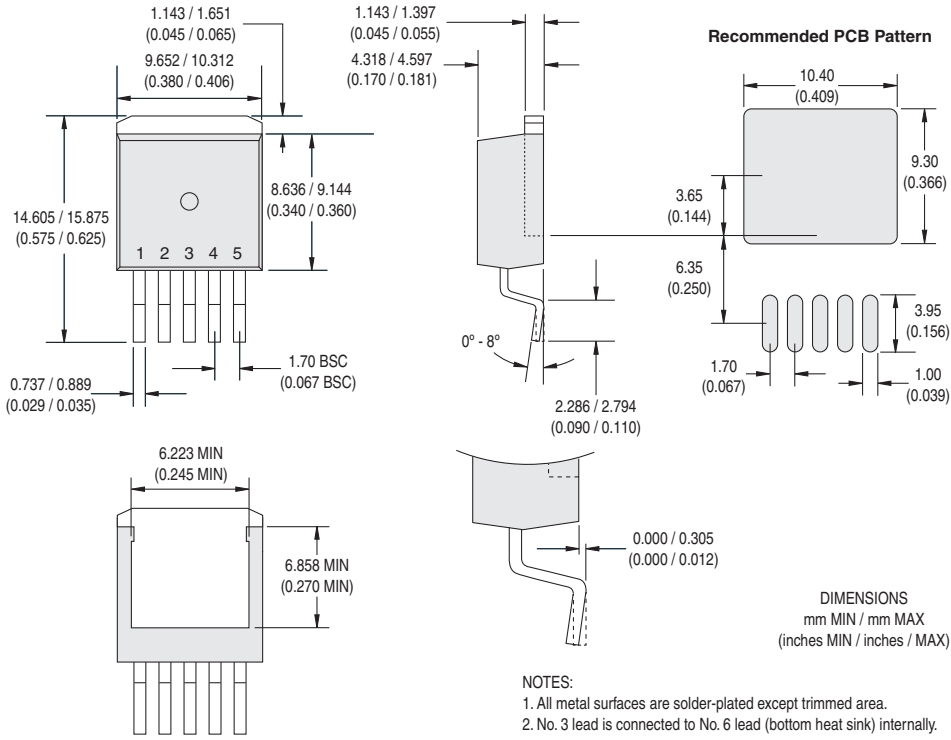
4.4 Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable, and the use of a short drying bake may be necessary. Chlorine-based or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

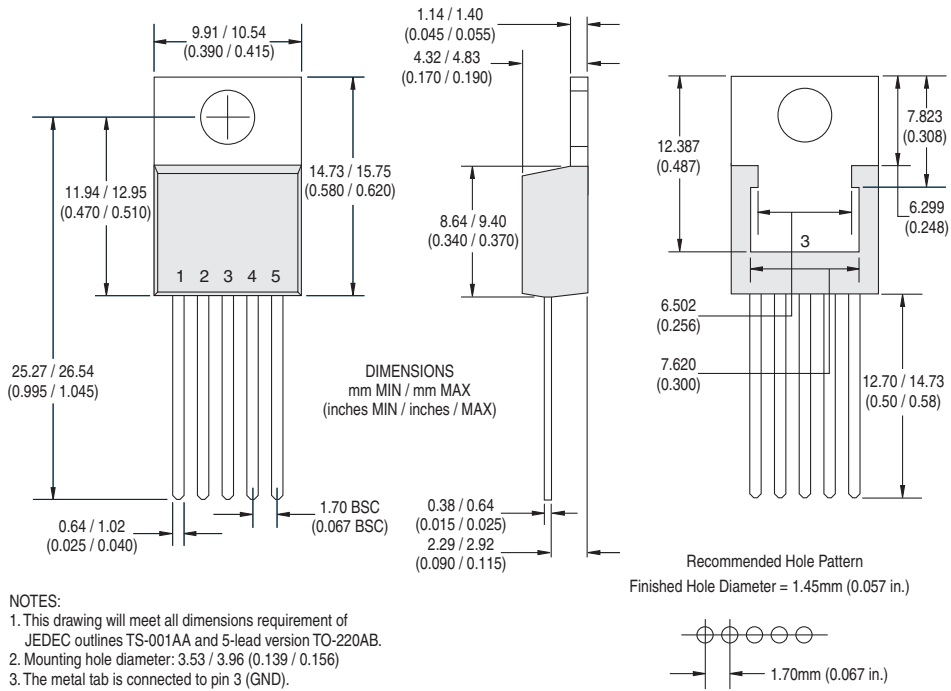


4.5 Mechanical Dimensions

4.5.1 IXD_630YI (5-Lead TO-263)



4.5.2 IXD_630CI (5-Lead TO-220)



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